

AMENDMENTS TO THE TITLE AND SPECIFICATION**In the Title:**

Please amend the Title as follows:

SEMICONDUCTOR DEVICE HAVING AN IMPROVED CONNECTION
ARRANGEMENT BETWEEN A SEMICONDUCTOR PELLET AND BASE
SUBSTRATE ELECTRODES ~~AND METHOD OF MANUFACTURE THEREOF~~

In the Specification:

Col. 1, after the title, insert the following paragraph (which replaces the paragraph inserted by the Preliminary Amendment of March 26, 2002):

More than one reissue application has been filed for the reissue of USP 5,777,391. These reissue applications are the present application Serial No. 09/613,541, filed on July 7, 2000, and U. S. Serial No. 10/105,236, filed on March 26, 2002, which is a continuation of the present reissue application Serial No. 09/613,541, filed July 7, 2000.